

3A, 50V - 1000V High Efficient Surface Mount Rectifier

FEATURES

- Glass passivated chip junction
- Ideal for automated placement
- Low forward voltage drop
- Low profile package
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- High frequency rectification
- Freewheeling application
- Switching mode converters and inverters in computer and telecommunication

MECHANICAL DATA

- Case: DO-214AB (SMC)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.210g (approximately)

KEY PARAMETERS				
PARAMETER	VALUE	UNIT		
I _F	3	Α		
V_{RRM}	50 - 1000	V		
I _{FSM}	150	Α		
T _{J MAX}	150	°C		
Package	DO-214AB (SMC)			
Configuration	Single die			









DO-214AB (SMC)



PARAMETER	SYMBOL	HS3A	HS3B	HS3D	HS3F	HS3G	HS3J	нѕзк	HS3M	UNIT
Marking code on the device		HS3A	HS3B	HS3D	HS3F	HS3G	HS3J	HS3K	HS3M	
Repetitive peak reverse voltage	V_{RRM}	50	100	200	300	400	600	800	1000	V
Reverse voltage, total rms value	V _{R(RMS)}	35	70	140	210	280	420	560	700	V
Forward current	I _F	3			Α					
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	I _{FSM}	ъм 150			А					
Junction temperature	TJ	T _J - 55 to +150			°C					
Storage temperature	T _{STG}	- 55 to +150			°C					



THERMAL PERFORMANCE				
PARAMETER	SYMBOL	TYP	UNIT	
Junction-to-ambient thermal resistance	$R_{\Theta JA}$	60	°C/W	

PARAMETER		CONDITIONS	SYMBOL	TYP	MAX	UNIT
(1)	HS3A HS3B HS3D HS3F	I _F = 3A, T _J = 25°C	V _F	-	1.0	V
Forward voltage ⁽¹⁾	HS3G			-	1.3	V
	HS3J HS3K HS3M			-	1.7	V
D (2)		T _J = 25°C		-	10	μA
Reverse current @ rated V _R ⁽²⁾		T _J = 125°C	- I _R	-	250	μΑ
Junction capacitance	tion capacitance $\begin{pmatrix} HS3A \\ HS3B \\ HS3D \\ HS3F \\ HS3G \end{pmatrix}$ $\begin{pmatrix} 1MHz, V_R = 4.0V \end{pmatrix}$ $\begin{pmatrix} C_J \end{pmatrix}$		C _J	80	-	pF
	HS3J HS3K HS3M			50	-	pF
Reverse recovery time	HS3A HS3B HS3D HS3F HS3G	I _F = 0.5A, I _R = 1.0A, I _{rr} = 0.25A	t _{rr}	-	50	ns
	HS3J HS3K HS3M			-	75	ns

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION				
ORDERING CODE ⁽¹⁾	PACKAGE	PACKING		
HS3x	DO-214AB (SMC)	3,000 / Tape & Reel		

Notes:

1. "x" defines voltage from 50V(HS3A) to 1000V(HS3M)



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.1 Forward Current Derating Curve

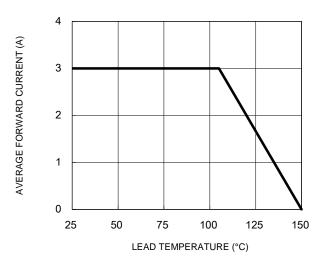


Fig.3 Typical Reverse Characteristics

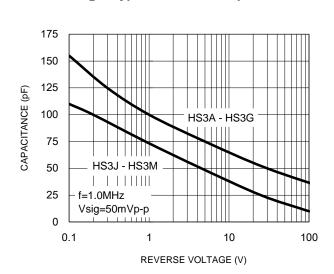
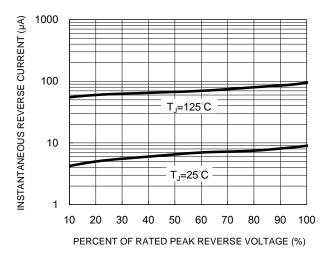


Fig.2 Typical Junction Capacitance

Fig.4 Typical Forward Characteristics



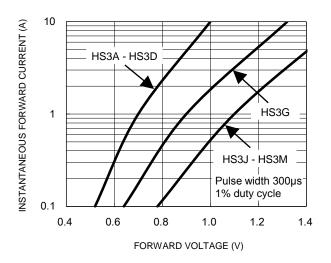
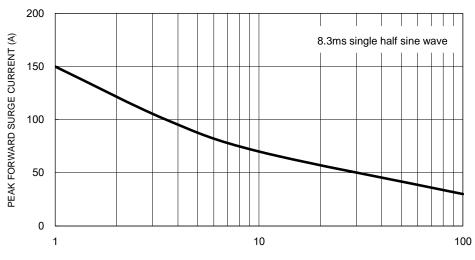


Fig.5 Maximum Non-Repetitive Forward Surge Current



NUMBER OF CYCLES AT $60\ Hz$

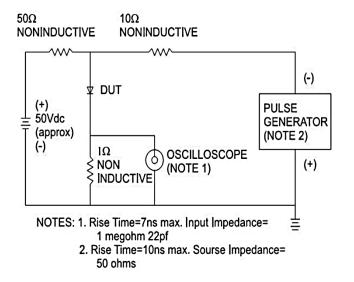


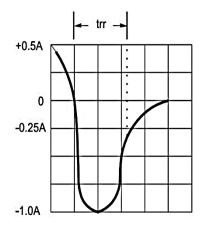


CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.6 Reverse Recovery Time Characteristic and Test Circuit Diagram



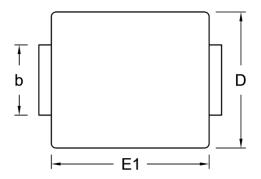


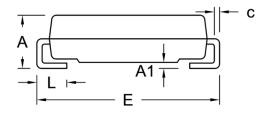




PACKAGE OUTLINE DIMENSIONS

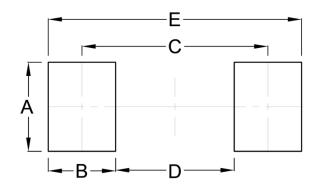
DO-214AB (SMC)





DIM. Unit		(mm)	Unit ((inch)
Dilvi.	Min.	Max.	Min.	Max.
Α	2.00	2.62	0.079	0.103
A1	0.10	0.20	0.004	0.008
b	2.90	3.20	0.114	0.126
С	0.15	0.31	0.006	0.012
D	5.59	6.22	0.220	0.245
Е	7.75	8.13	0.305	0.320
E1	6.60	7.11	0.260	0.280
L	1.00	1.60	0.039	0.063

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
Α	3.30	0.130
В	2.50	0.098
С	6.90	0.272
D	4.40	0.173
E	9.40	0.370

MARKING DIAGRAM



P/N = Marking Code G = Green Compound

ΥW = Date Code F = Factory Code

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